

01_Cover page

ECBMCU105H Ver.C

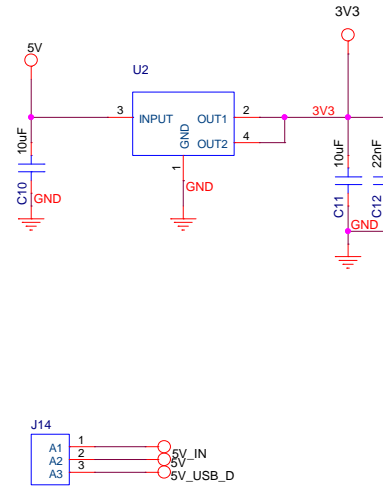
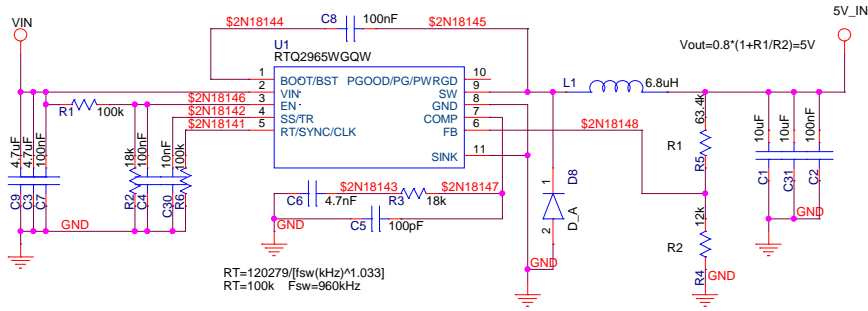
Sheet 1	Cover Page
Sheet 2	Power
Sheet 3	MCU_SYS
Sheet 4	CONN
Sheet 5	Debug_board_CONN
Sheet 6	Debug_board_SYS

The type and specification of the components refer to the BOM

				NA	
				ECA NO	DATE
DESIGNED		ECBMCU105H			
REVIEWED					
		VER	PART_NUMBER	SHEET 1 OF 6	
		C			

02_POWER

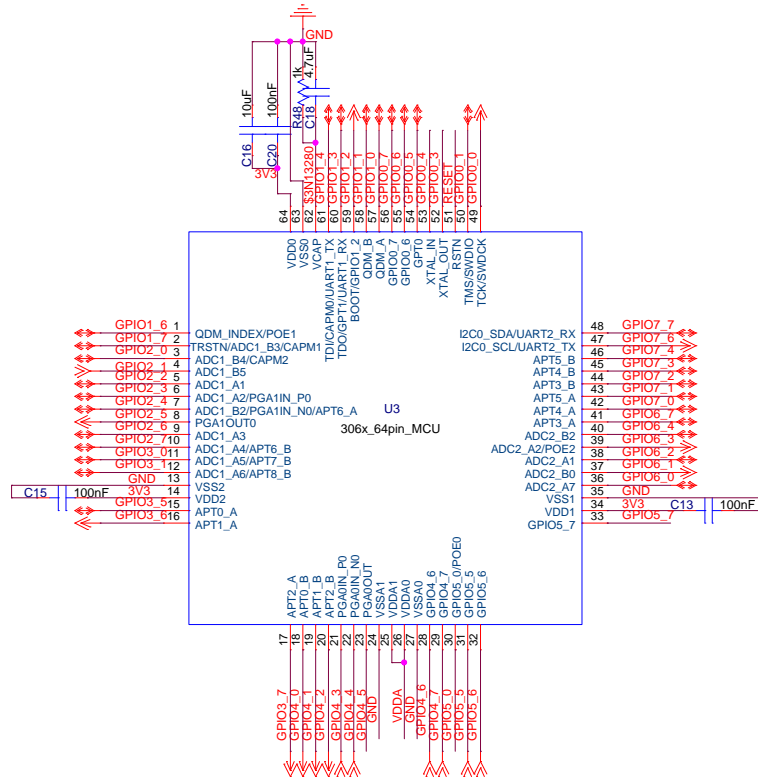
24V/12V-5V



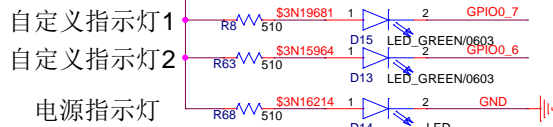
The type and specification of the components refer to the BOM

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				ECA NO	DATE
DESIGNED				ECBMCU105H	
REVIEWED					
		VER	PART_NUMBER	SHEET 2 OF 6	
		C			

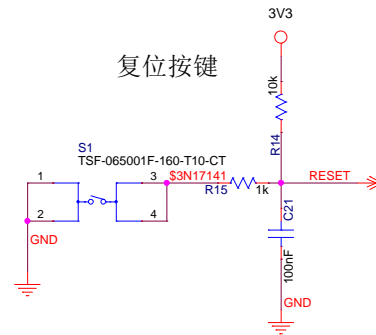
03_MCU_SYS



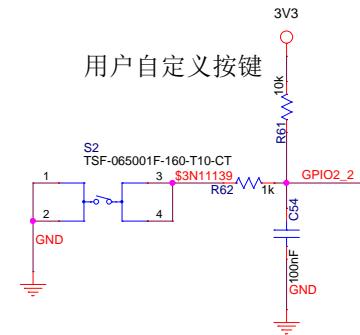
Boot选择: R17 NC--正常启动模式
R17上件--烧录模式



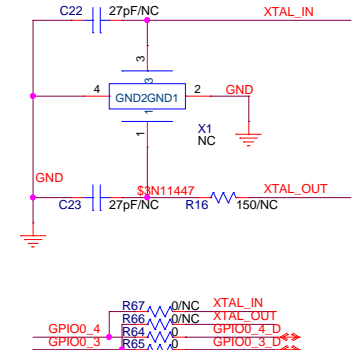
复位按键



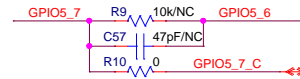
用户自定义按键



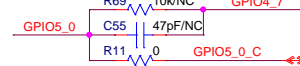
晶体



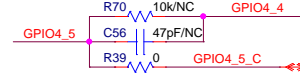
PGA2负反馈



PGA1负反馈



PGA0负反馈



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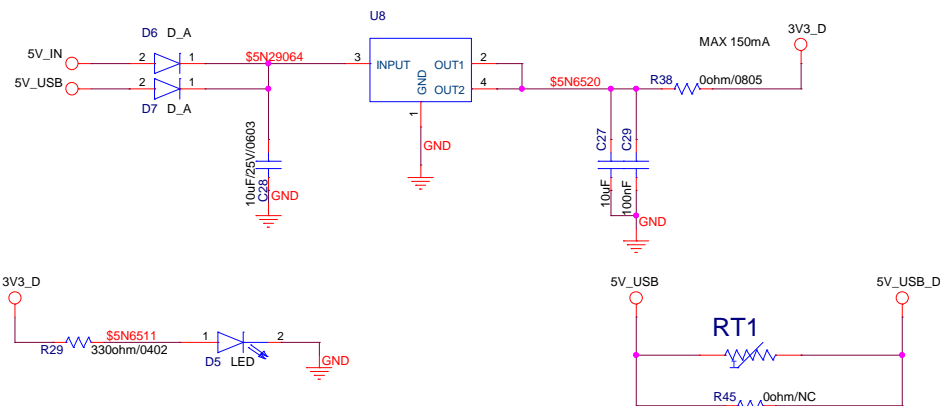
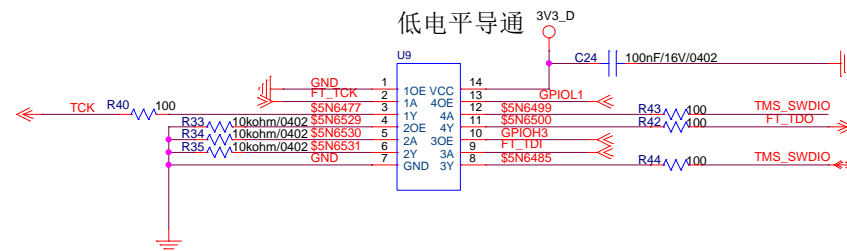
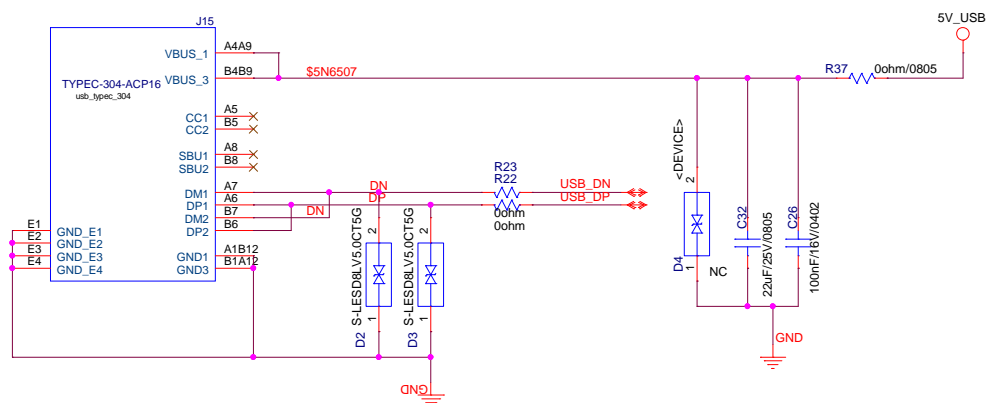
				NA	
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D



				NA	
				ECA NO	DATE
DESIGNED		ECBMCU105H			
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		VER	PART_NUMBER	SHEET 4 OF 6	
		C			

05_Debug_board_CONN



螺丝孔

M1
ICT-LOCATING-POINT

M2
ICT-LOCATING-POINT

M3
ICT-LOCATING-POINT

M4
ICT-LOCATING-POINT

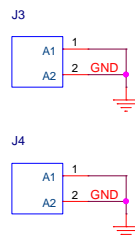
M5
ICT-LOCATING-POINT

M6 RIVET-HOLE100-R2R5 M7 RIVET-HOLE100-R2R5

M8 RIVET-HOLE100-R2R5 M9 RIVET-HOLE100-R2R5

定位孔

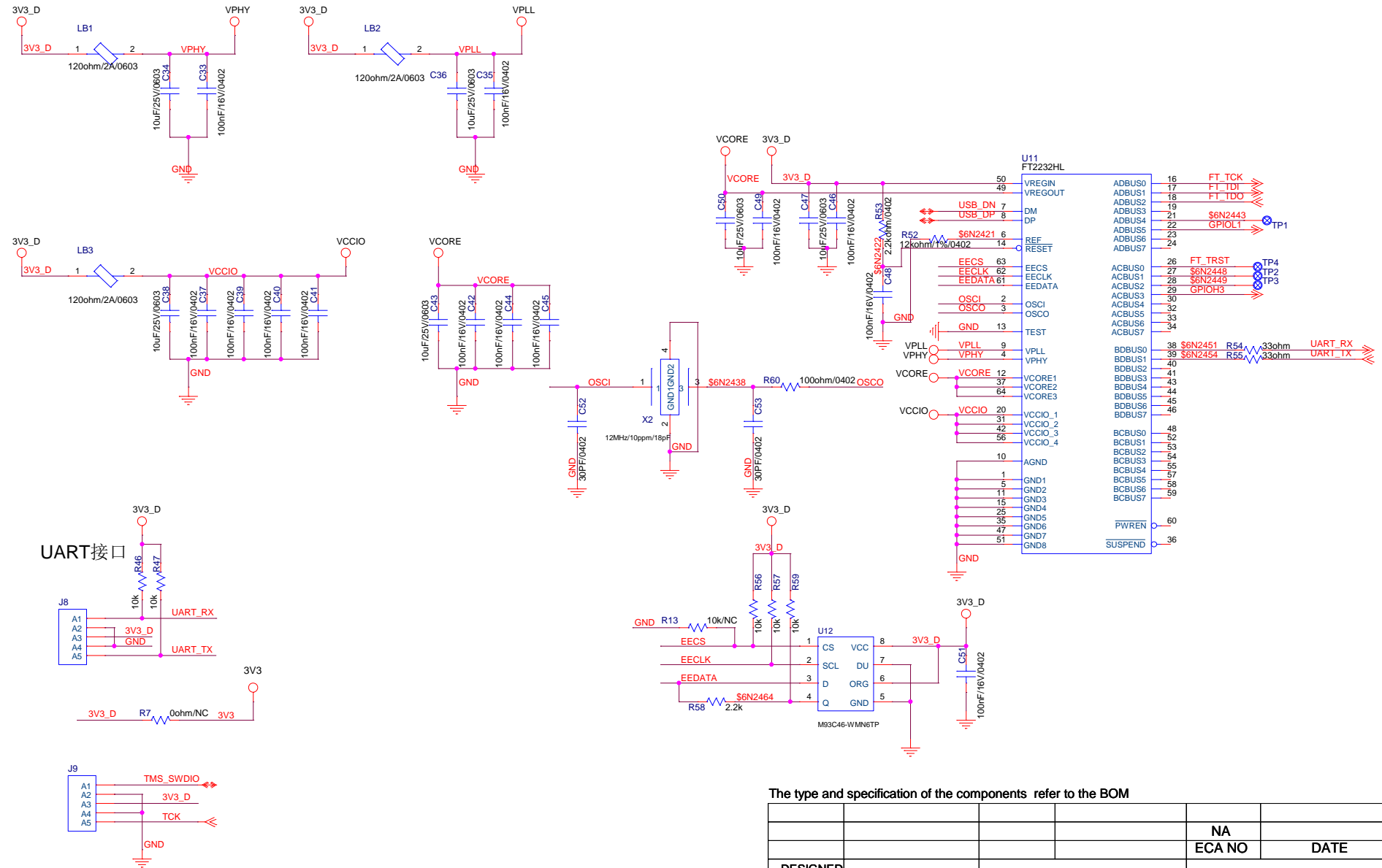
光学定位



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REVIEWED					
		VER	PART_NUMBER	SHEET 5 OF 6	
		C			

06_Debug_board_SYS



The type and specification of the components refer to the BOM

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REVIEWED		VER	PART_NUMBER	SHEET 6 OF 6	
		C			